

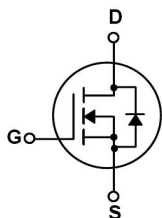
/ Descriptions

/ Features

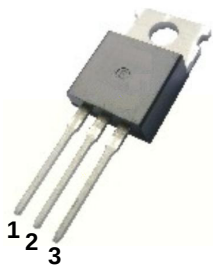
/ Applications

DC/DC

/ Equivalent Circuit

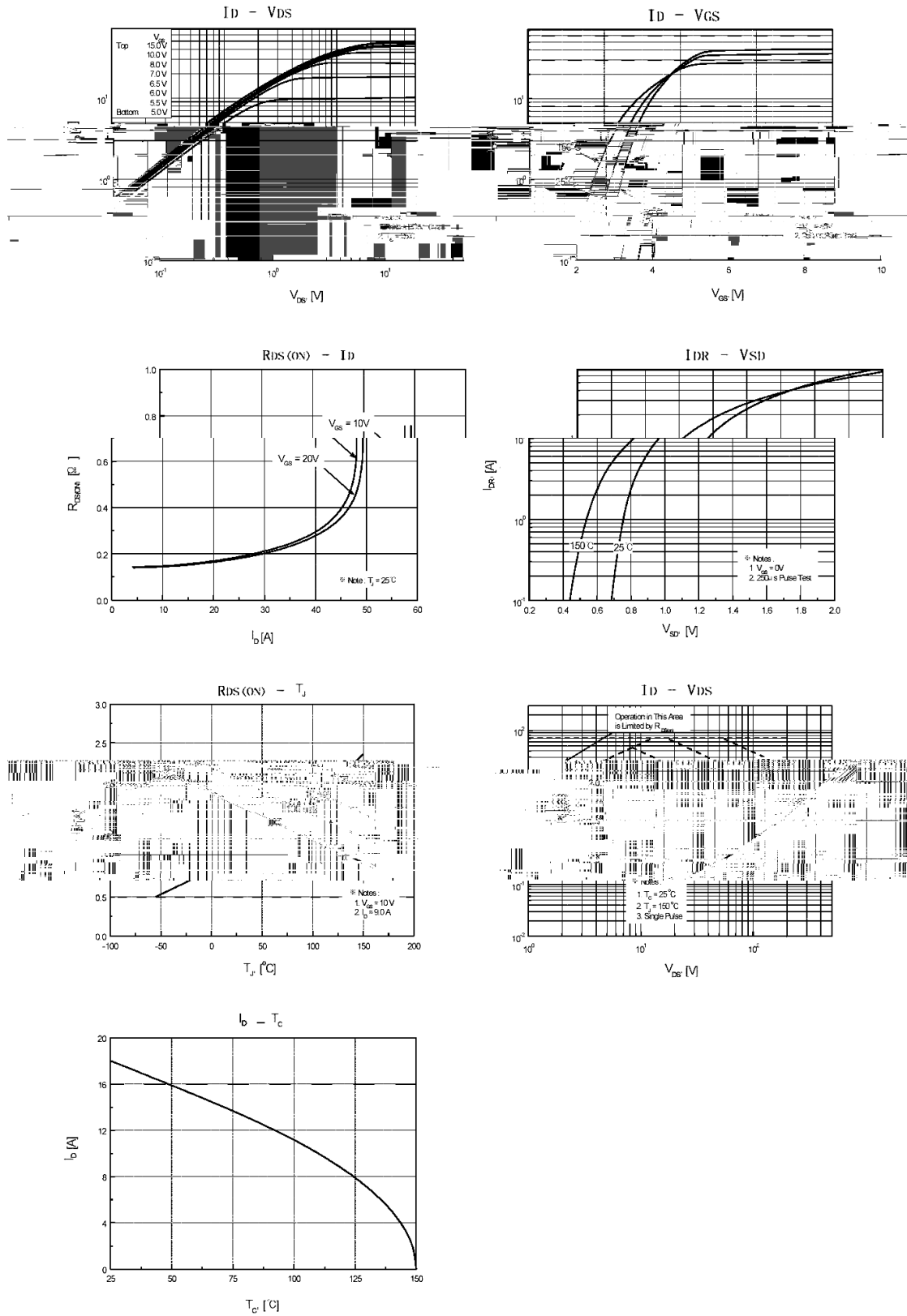


/ Pinning

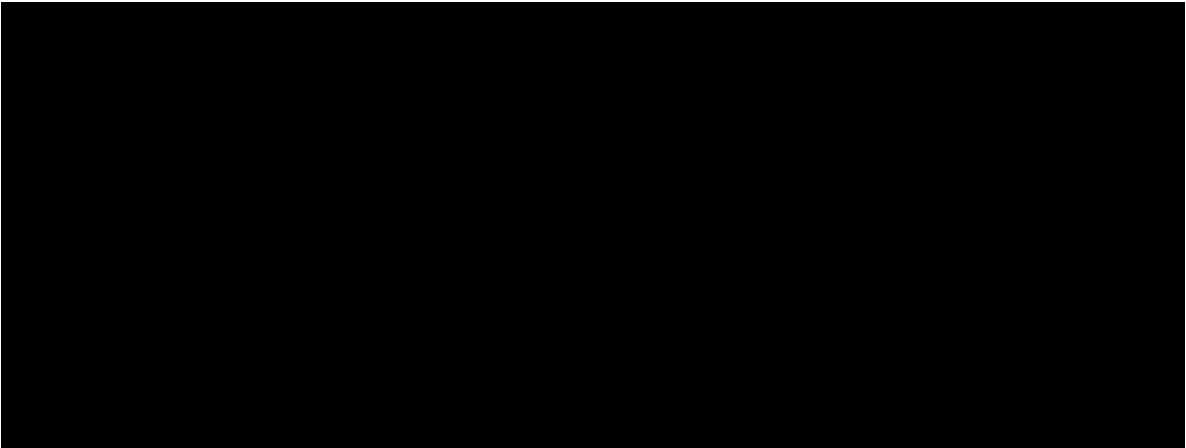


/ h_{FE} Classifications & Marking

/ Electrical Characteristic Curve

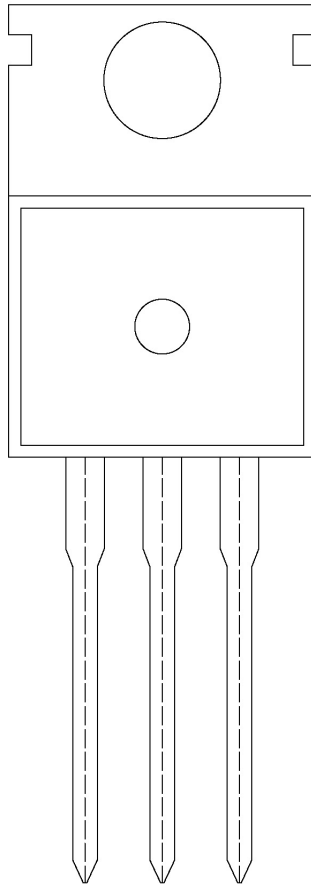


/ Package Dimensions



Dimensions in Millimeters				Dimensions in Millimeters			
Symbol	Min	Max	Typ	Symbol	Min	Max	Typ
A	9.8	10.2		C	1.2		
B	13.56	13.64		B1	1.63		
J	15.7	16.1		B	9.0		9
b	12.6	13.6		C1	2.2		2
b1	9.6	10.6		a1	0.7		0
C	1.3	1.37		3	1.45	1.52	1.48
Q2	1.35	1.47		E	2.34	2.74	
				Q2	1.25	1.45	

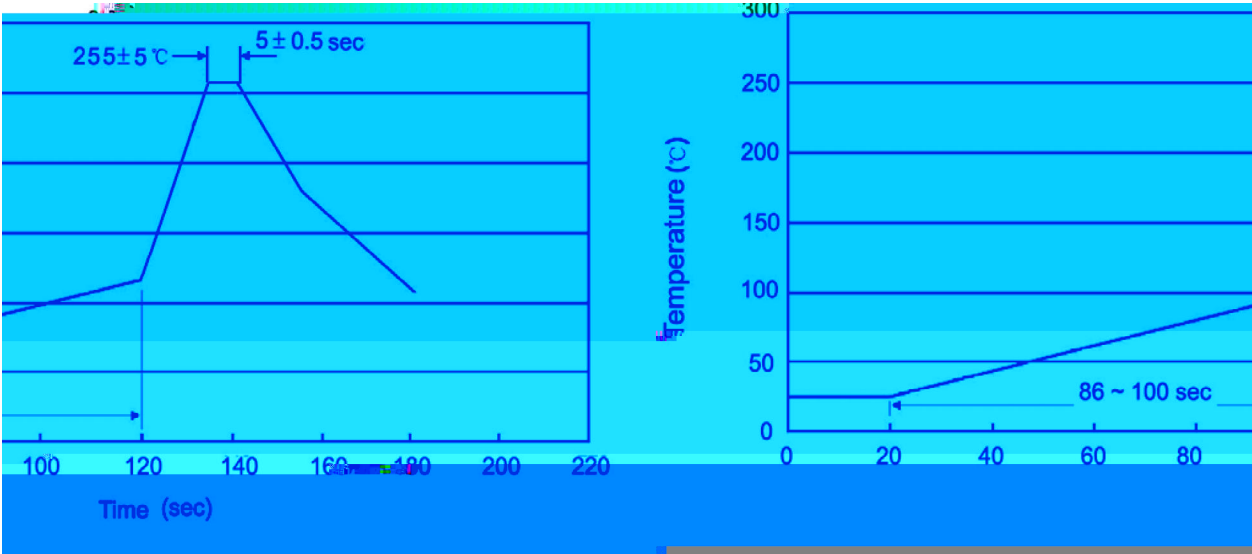
/ Marking Instructions



IRF640

IRF640

() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	只 袋	袋 盒	只 盒	盒 箱	只 箱	袋	盒	箱

封装形式	包装数量					包装尺寸 :		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices